

Title (en)  
COPPER COOLING PLATE FOR METALLURGICAL FURNACES

Title (de)  
KUPFERKÜHLPLATTE FÜR METALLURGISCHE ÖFEN

Title (fr)  
PLAQUE DE REFROIDISSEMENT EN CUIVRE DESTINEE A DES FOURS METALLURGIQUES

Publication  
**EP 1218549 A1 20020703 (DE)**

Application  
**EP 00965931 A 20000907**

Priority  
• DE 19943287 A 19990910  
• EP 0008726 W 20000907

Abstract (en)  
[origin: US6843958B1] A metallurgical furnace provided with a refractory lining and an outer furnace steel jacket, having copper cooling plates, wherein a flow of cooling medium flows through the cooling plates arranged between the furnace steel jacket and the refractory lining. Cooling medium pipes of the copper cooling plate provided for supplying and removing the cooling medium are guided through the furnace steel jacket to the exterior and are gas-tightly welded to the furnace steel jacket. The copper cooling plate is connected free of play in all spatial directions to the furnace steel jacket, in addition to attachment by way of the cooling medium pipes welded to the furnace steel jacket, by at least one fixed-point fastening element that is welded to the furnace steel jacket. The at least one fixed-point fastening element is arranged within at least one of the upper part and the lower part of the copper cooling plate in immediate proximity of the cooling medium pipes.

IPC 1-7  
**C21B 7/10**

IPC 8 full level  
**C21B 7/10** (2006.01); **F27B 1/24** (2006.01); **F27D 1/12** (2006.01)

CPC (source: EP KR US)  
**C21B 7/10** (2013.01 - EP KR US)

Designated contracting state (EPC)  
AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE

DOCDB simple family (publication)  
**US 6843958 B1 20050118**; AR 025597 A1 20021204; AT E258994 T1 20040215; AU 7650700 A 20010417; AU 770082 B2 20040212; BR 0013293 A 20020702; CA 2384455 A1 20010322; CN 1206371 C 20050615; CN 1373814 A 20021009; CZ 2002864 A3 20020814; DE 19943287 A1 20010315; DE 50005224 D1 20040311; EG 22979 A 20031231; EP 1218549 A1 20020703; EP 1218549 B1 20040204; ES 2215728 T3 20041016; HU P0204298 A2 20030328; JP 2003509588 A 20030311; KR 20020029782 A 20020419; MX PA02002533 A 20021023; PL 354311 A1 20040112; RU 2245372 C2 20050127; SK 3412002 A3 20021203; TR 200200624 T2 20020923; TW 533240 B 20030521; WO 0120045 A1 20010322; ZA 200202202 B 20021018

DOCDB simple family (application)  
**US 7065002 A 20020611**; AR P000104693 A 20000907; AT 00965931 T 20000907; AU 7650700 A 20000907; BR 0013293 A 20000907; CA 2384455 A 20000907; CN 00812711 A 20000907; CZ 2002864 A 20000907; DE 19943287 A 19990910; DE 50005224 T 20000907; EG 20001140 A 20000909; EP 0008726 W 20000907; EP 00965931 A 20000907; ES 00965931 T 20000907; HU P0204298 A 20000907; JP 2001523414 A 20000907; KR 20027003028 A 20020307; MX PA02002533 A 20000907; PL 35431100 A 20000907; RU 2002109230 A 20000907; SK 3412002 A 20000907; TR 200200624 T 20000907; TW 89118308 A 20000907; ZA 200202202 A 20020319